



# ELECTRICAL MODEL REPORT

## MODEL SUMMARY

This is an electrical model of the zSFP+ connector. This connector supports 10 Gbps Ethernet and 16 Gbps Fiber Channel applications with the ability to support 25/28 Gbps applications.

This model can be used as a standalone model for analysis of connector performance or with other models to complete a channel.

Further information regarding this connector product line and other related Molex zSFP+ products can be found at <http://www.molex.com/> .

**zSFP+ Connector**



## APPLICABLE PART NUMBER(S): 170382

<b>MODEL TYPE:</b> S-parameter	<b>MODEL FORMAT:</b> Touchstone (*.sNp)
<b>MODEL FILENAME:</b> SP-170382-0001_revC.s8p	<b>DATA FORMAT:</b> Real/Imaginary
<b>MODEL BASIS:</b> Analytical 3-D field solution	<b>MODEL SOURCE:</b> Ansoft HFSS version 14.0
<b>BANDWIDTH:</b> DC - 40.96 GHz	<b>RESOLUTION:</b> 10 MHz steps
<b>REFERENCE:</b> 50 ohms	<b>NUMBER OF POINTS:</b> 4097 (4096 + 1 DC)
<b>NUMBER OF CHANNELS:</b> 2 differential	<b>NUMBER OF PORTS:</b> 8 single-ended
<b>CHANNEL TYPE:</b> Coupled pairs + reference	<b>VALIDATION:</b> TS-170382-0001
<b>MODEL APPLICATION:</b> Fibre Channel, Ethernet	<b>DATA RATE:</b> 28 Gbps

### DISCLAIMERS:

Information contained in this document is simulated. Molex Incorporated does not guarantee the performance of the final product to the information provided in this document.

Molex does not represent, warrant or guarantee the accuracy of the information, expressly disclaims all warranties including the implied warranties of merchantability and fitness for particular purpose and shall not be liable for any damages whatsoever arising from use of, or inability to use, the information contained in this document or accompanying electronic file.

The user is responsible for verifying the results of their use of this information, and assumes all risk of doing or not doing so. Use of the electronic file evidences user's agreement to the above terms.

<b>REVISION:</b> <b>C</b>	<b>ECN INFORMATION:</b> EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	<b>TITLE:</b> <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	<b>SHEET No.</b> <b>1 of 8</b>
<b>DOCUMENT NUMBER:</b> <b>EE-170382-0001</b>	<b>CREATED / REVISED BY:</b> <b>K. Balasubramanian</b>	<b>CHECKED BY:</b> <b>R. Benson</b>	<b>APPROVED BY:</b> <b>P. Casher</b>



# ELECTRICAL MODEL REPORT

## MODEL DESCRIPTION

This model contains 2 differential pairs (and their associated grounds) arranged in a G-S-S-G format circuit board interfaces, which results in an 8-port, single-ended S-parameter matrix. Two power pins are not part of the ports. The signal path represented by the model consists of a surface-mount host card, and an edge card connector inserted into one side of the connector.

The electrical model was simulated using Ansoft HFSS in the Frequency domain. The frequency range of this simulation is from 0 GHz to 40.96 GHz. With Ansoft HFSS the DC values of the S-parameters are extrapolated from the lowest solved frequency (10 MHz).

## CONDUCTOR TO PORT MAPPING TABLE

### SIGNAL PATHS

Terminals (Host Board)	Ports (Host Board)	Ports (Edge Card)
12	1	2
13	3	4
18	5	6
19	7	8

REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>2 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>



# ELECTRICAL MODEL REPORT

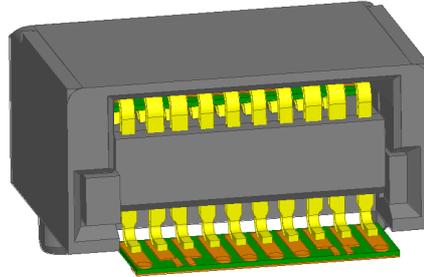
## PART ILLUSTRATIONS

### Connector

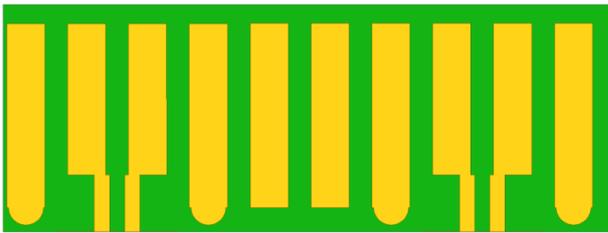
Side



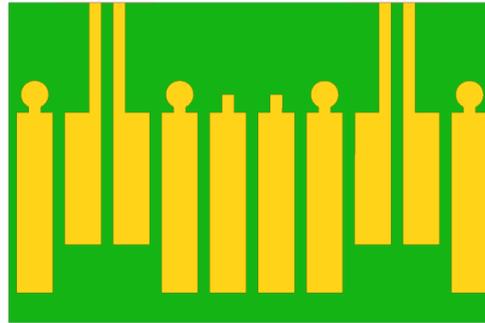
Perspective



Host Card



Edge Card



#### Host Board Construction Details

Thickness: 0.148mm  
 Layers: 2 (Microstrip & Ground)  
 Board Material: Dk=3.8, Df=0.015  
 Copper: 1.5 oz. (.05mm)

#### Edge Card Pads

Pitch: 0.8 mm  
 Ground: 3.0 x 0.6 mm  
 Signal: 2.2 x 0.6 mm

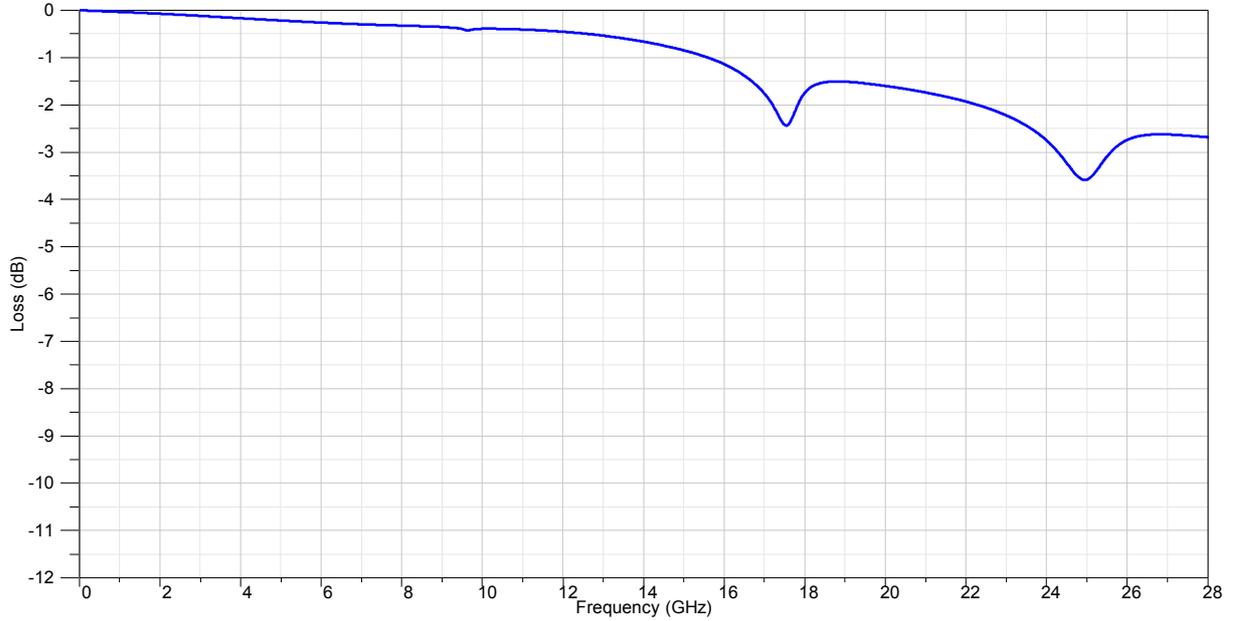
REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>3 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>



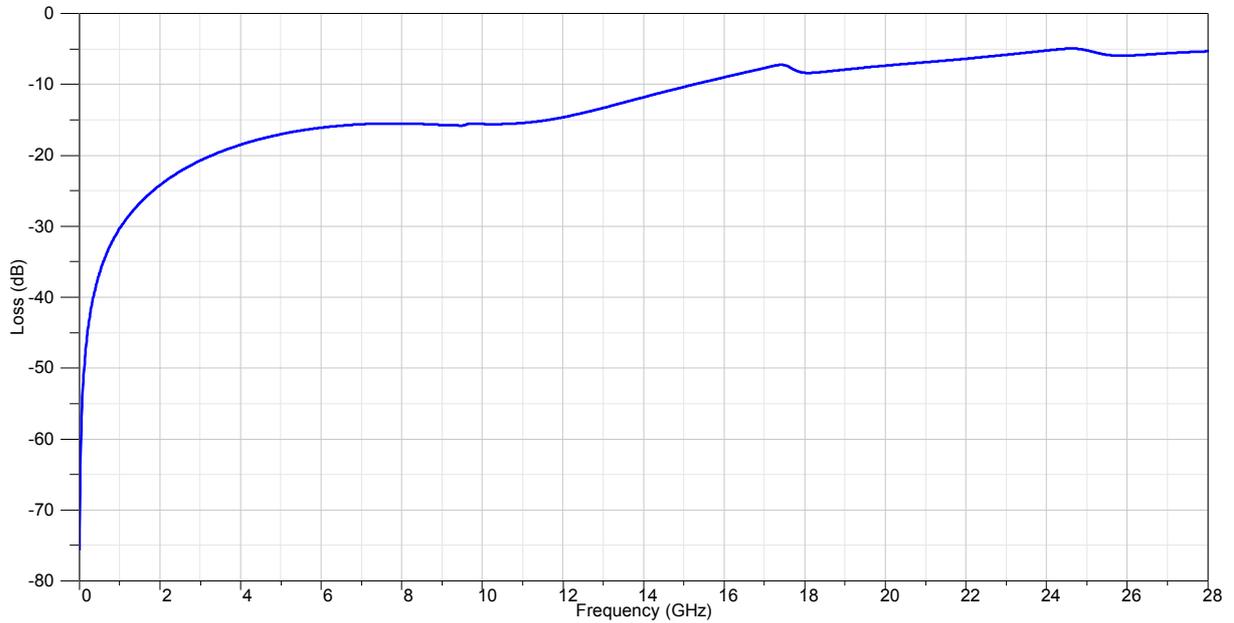
# ELECTRICAL MODEL REPORT

## REFERENCE RESULTS

Differential Insertion Loss



Differential Return Loss



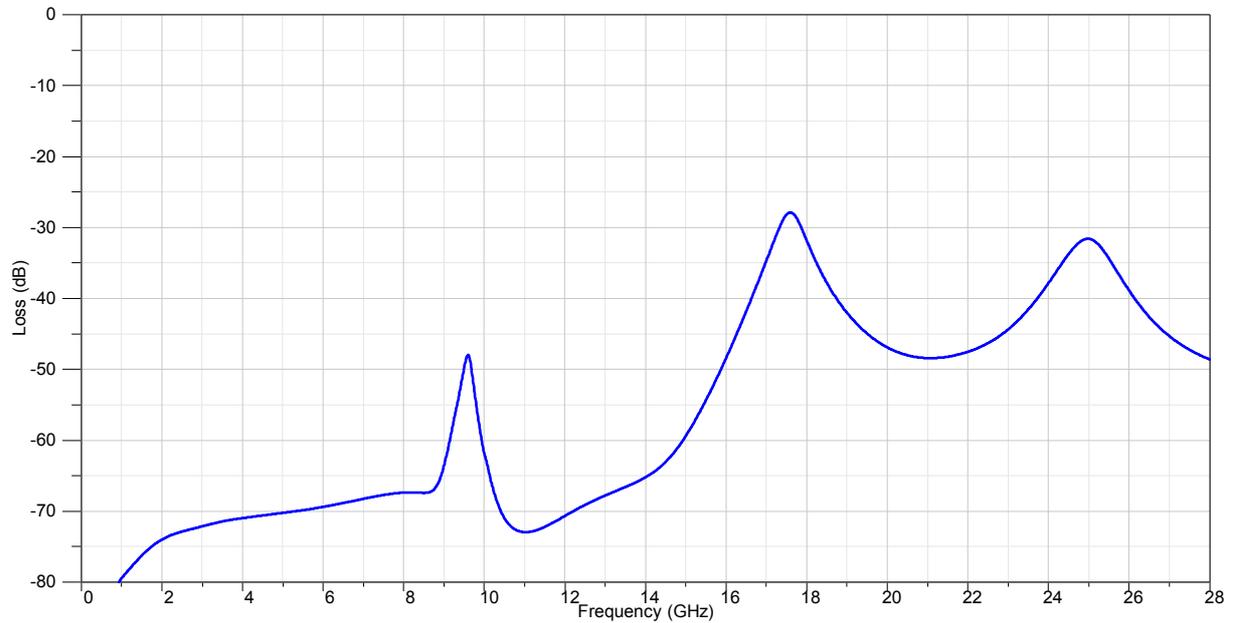
REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>4 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>



# ELECTRICAL MODEL REPORT

## REFERENCE RESULTS

Near-end Differential Crosstalk



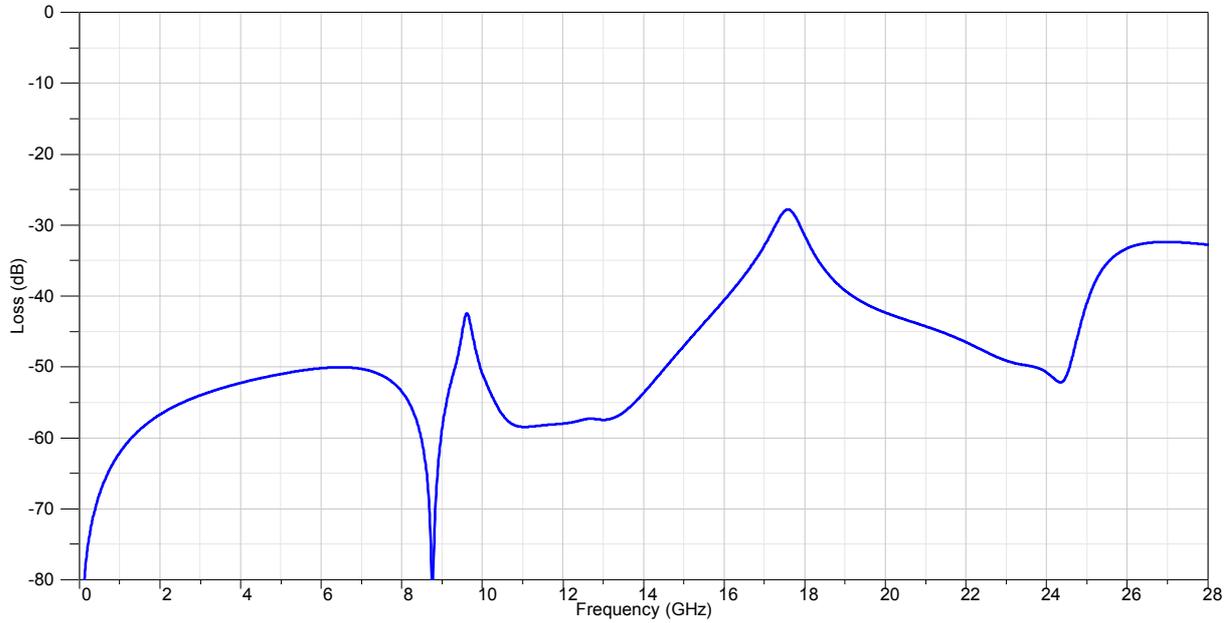
REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>5 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>



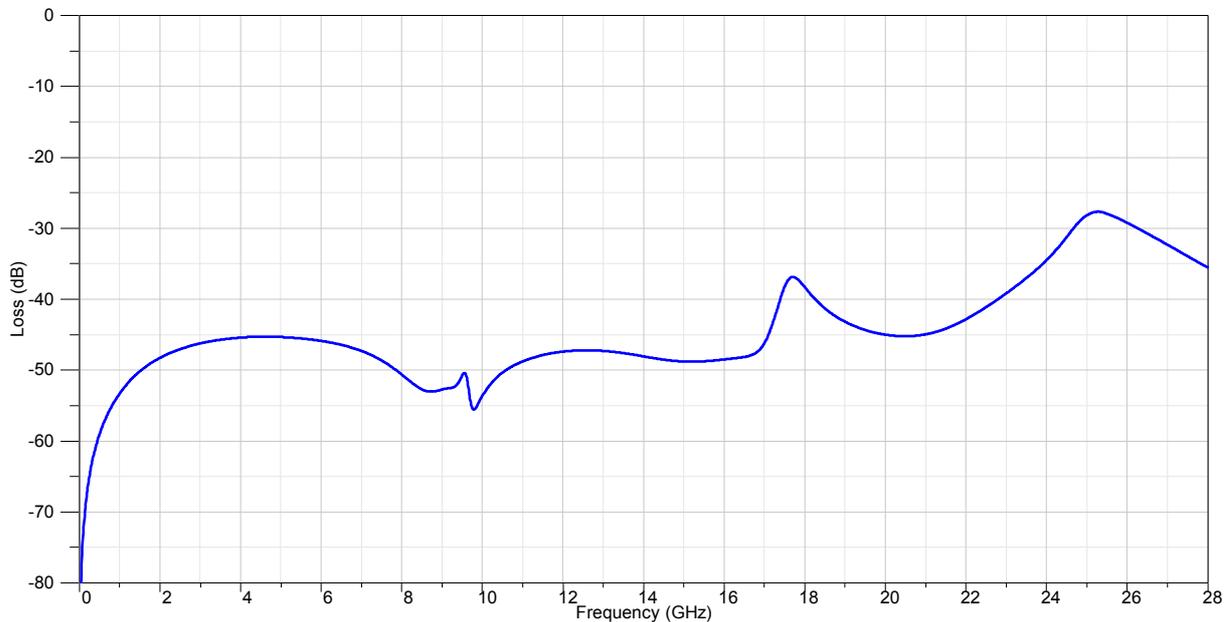
# ELECTRICAL MODEL REPORT

## REFERENCE RESULTS

### Mode Conversion - Thru



### Mode Conversion - Reflected



REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>6 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>

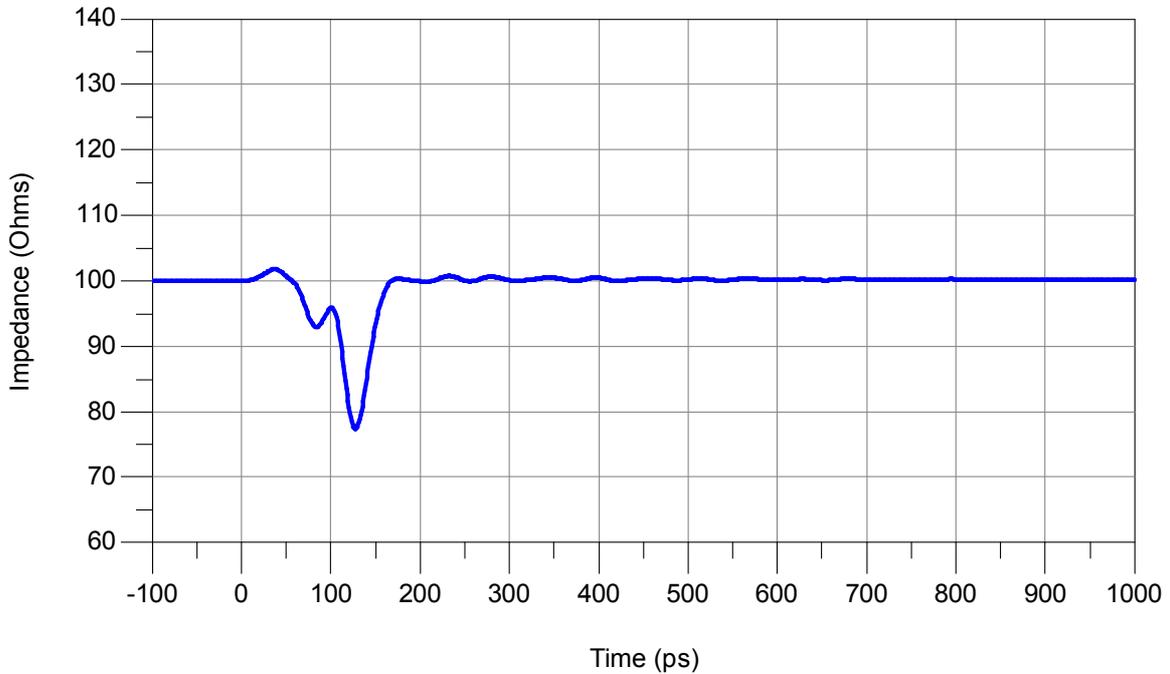


# ELECTRICAL MODEL REPORT

## REFERENCE RESULTS

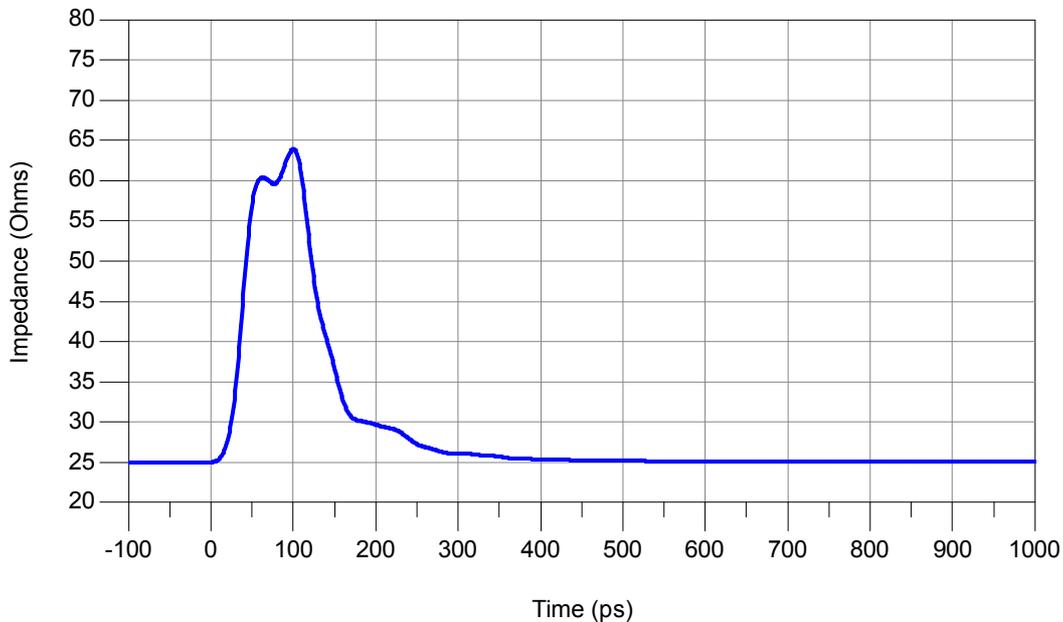
### Differential TDR Response

- Rise-time of 18ps (20-80%), representative of 14.025Gbps applications



### Common Mode TDR Response

- Rise-time of 18ps (20-80%), representative of 14.025Gbps applications

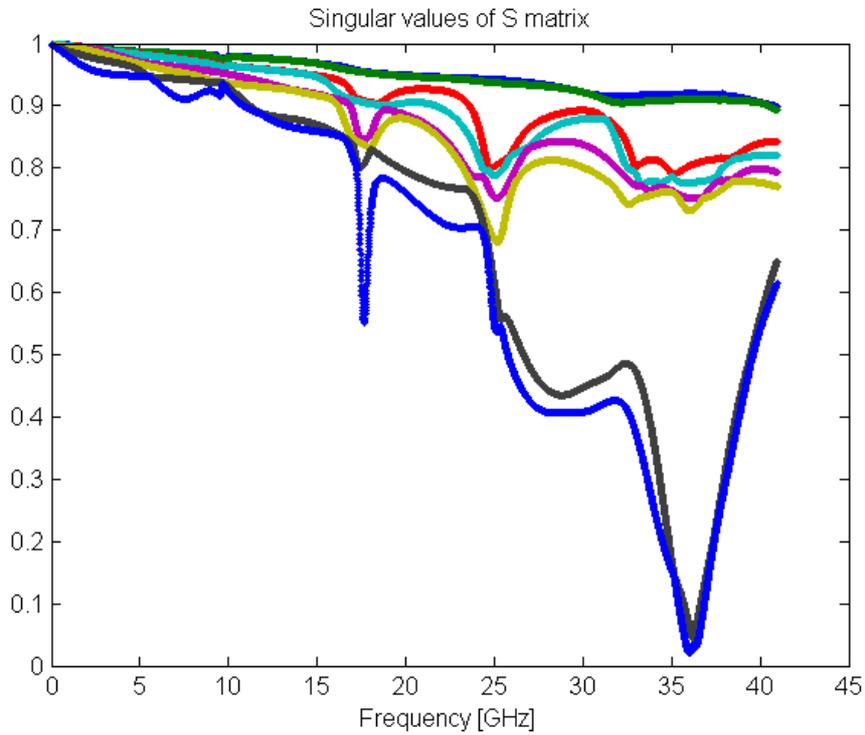


REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>7 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>



# ELECTRICAL MODEL REPORT

## Model Passivity



REVISION: <b>C</b>	ECN INFORMATION: EC No: <b>UCP2012-3087</b> DATE: <b>03/19/2012</b>	TITLE: <b>Electrical Model Documentation</b> <b>zSFP+, Surface Mount</b> <b>MOLEX CONFIDENTIAL</b>	SHEET No. <b>8 of 8</b>
DOCUMENT NUMBER: <b>EE-170382-0001</b>	CREATED / REVISED BY: <b>K. Balasubramanian</b>	CHECKED BY: <b>R. Benson</b>	APPROVED BY: <b>P. Casher</b>